BRIGHT VIEW ELECTRONICS CO.,LTD

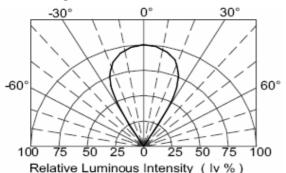
ULTRA BRIGHTNESS LED LAMP

BVU-5A6WI5

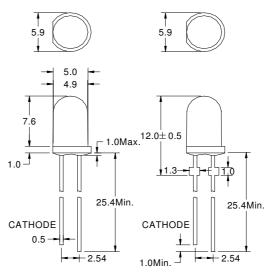
DESCRIPTION

Dice Material : GaN Blue Light Color : White Color Lens Color : Water Transparent Stand-Off P/N : BVU-5A6WI5 R

RADIATION PATTERN







Tolerance ± 0.25 mm

ABSOLUTE MAXIMUM RATINGS AT Ta = 25 $^{\circ}$

			PARAMET	ER		•			MAX.			UNIT
Power Dis	sipation (Pd)							1:	20		mW
Continuous	Forward	Current	(IF)						30			mA
Peak Forw	ard Curre	ent (1/10	Duty Cycl	e , 10ms	s Pulse	Width)	(IFP)		100			mA
Reverse V	oltage (V	R)							ļ	5		V
Derating L	inear Fro	m 25 ℃							$\begin{array}{c c c c c c c }\hline & 120 \\ & 30 \\ \hline & 100 \\ \hline & 5 \\ \hline & 0.4 & r \\ \hline & -30 \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$			mA/⁰C
Operating	Temperat	ure Rang	je (Topr)						−30 °	C to +	85 ℃	
Storage Temperature Range (Tstg) Lead Solder Temperature 1.6 mm Below Package 260 °C for 5 seconds ELECTRICAL / OPTICAL CHARACTERISTICS AT Ta = 25 ℃										c to +	100 ℃	
Lead Sold	er Tempe	erature 1.0	6 mm Belo	w Pack	age 26	0 ℃ for	5 secon	ds (Tsl	d)			
ELECTRI	CAL / OF	TICAL (CHARAC	TERIST	ICS A	T Ta = 2	25 °C					
SYMBOL	F	PARAMETER TEST COND. MIN.		TYP.		Ν	MAX.					
VF	Forward	Voltage		l F = 2	20 mA			3.	3.2		4.0	
l r	Reverse	Current		V R :	= 5V					μA		
2 <i>θ</i> 1/2	Viewing				20 mA						Deg	
Ιv		s Intensity		l F = 2							mcd	
BIN GRA		-				ITENSI	TY / m	cd				
Bin	М	Ν	0	Р	Q	Tolerance ± 15%mcd						
Min.	2180	2800	3600	4650	6000	Please contact our sales department for mo					nore	
Max.	2800	3600	4650	6000	7800		information. IY COORDINATES					
BIN GRA		-	-			TY CO	ORDIN					-
WA1	х	0.26	0.26	0.275	0.275	WC1	Х	0.32				1
	у	0.2	0.24	0.26	0.22		у	0.29				
WA2	х	0.275	0.275	0.29	0.29	WC2	х	0.335	0.335	0.35	0.35	
	у	0.22	0.26	0.28	0.24		у	0.31	0.35	0.37	0.33	
WB1	х	0.29	0.29	0.305	0.305	WD1	х	0.35	0.35	0.365	0.365]
	у	0.24	0.28	0.305	0.265		у	0.33	0.37	0.39	0.35	
WB2	х	0.305	0.305	0.32	0.32	WD2	х	0.365	0.365	0.38	0.38	
	у	0.265	0.305	0.33	0.29		у	0.35	0.39	0.41	0.37	

*Bright View reserves the rights to alter specifications and remove availability of products at any time without notice.

*Dominant Wavelength, λd is according to CIE Chromaticity Diagram base on color of lamps.

* θ 1/2 is the off-axis angle where the luminous intensity is one half the on-axis intensity.

*These products are sensitive to static electricity. Caution must be taken strictly to avoid static electricity. www.DataSheet4U.com

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TYPICAL ELECTRICAL / OPTICAL CHARACTERISTIC CURVES

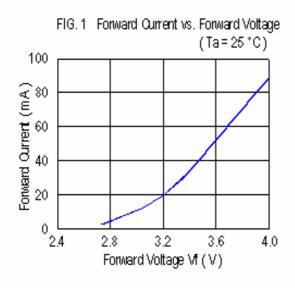
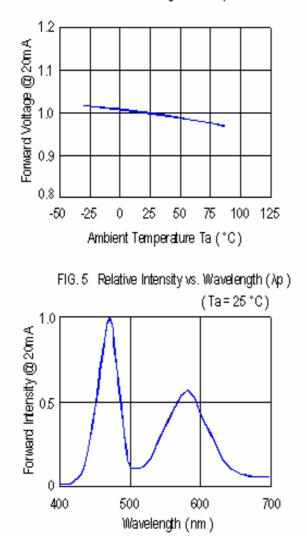


FIG. 3 Forward Voltage vs. Temperature



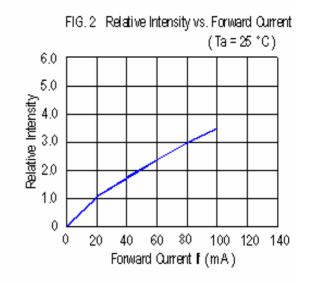
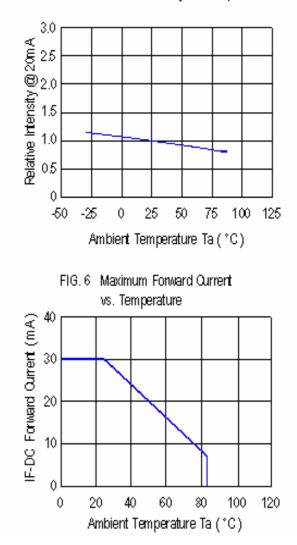


FIG. 4 Relative Intensity vs. Temperature





CAUTION FOR CLASS 1 ESD (MACHINE MODE)

Gallium Nitride (GaN) based light emitting diodes (LEDs) are extremely sensitive to electrostatic discharge (ESD). Users are strongly recommended to take necessary meter to test the static and avoid ESD when handing these products.

Bright View's BA, GN, WI series products are GaN based materials and are classified as "Class 1",(ESD endurance 50V or lower), any manufacturing site or workstation where GaN devices are handled should be rated and controlled at 50V or below.

Proper grounding of products or machines (via $1M\Omega$), using static dissipative mats, static dissipative containers, static dissipative working uniferms and shoes are considered to be effective against ESD.

An ionizer is recommended in the facility or environment where ESD may be generated easily, and soldering iron with a grounded tip is also recommended.

To install a protection device in the LED circuit to ensure the surge current and voltage not exceeding the max rating during on/off swithing.

When inspecting the final products in which LEDs are assembled, it is recommended to check whether the assembled LEDs are damaged by ESD or not. It is simple to find damaged LEDs by light-on or a VF test at lower current (below 1mA is recommended).

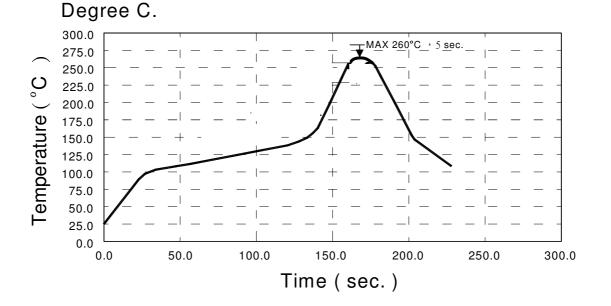
ESD damaged LEDs will show some unusual characteristics such as the remarkable increasing of leak current, the forward voltage become lower, or the LEDs do not light on at the low current.



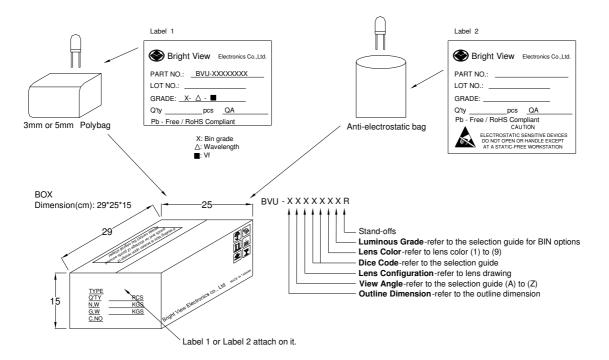
Apply to LAMP(DIP) series.

Description:

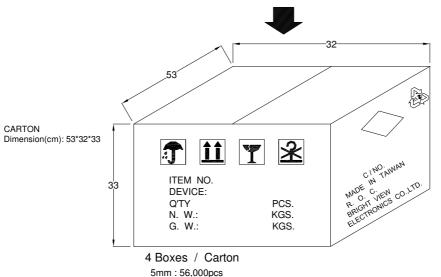
- (1) Manual soldering (Solder Iron)
 - (1.1) Temperature at tip of the iron: 300 °C Max.
 - (1.2) It's banned to load any stress on the resin during soldering.
 - (1.3) Soldering time: 5 sec. Max.(one time only)
 - (1.4) Leave 1.6mm of minimum distance from the base of epoxy.
- (2) Dip Soldering(Wave soldering-Solder Bath)
 - (2.1) Leave 1.6mm of minimum distance from the base of the epoxy. Soldering beyond the base of the tie bar(stand off) is recommended.
 - (2.2) When soldering, do not put stress on the LEDs during heating.
 - (2.3) Cutting the leadframes at high temperatures may cause LED failure.
 - (2.4) Never take next process until the component is cooled down to room temperature after reflow.
 - (2.5) After soldering, do not warp the circuit board.
 - (2.6) The recommended dip soldering profile is the following:







Device	Q'ty / Polybag (pcs)	Polybag / Box A	Fig.
5mm(T-1 3/4)	1000pcs	14 bags	Label 1
3mm(T-1)	1000pcs	20 bags	Label 1
Blue / Green / White	500pcs	18 bags	Label 2



Blue / Green / White : 36,000pcs